



OPEN
Compute Project

Alpha Networks Inc

SNX-61A0-486F

48-port 10G SFP+ & 4-port 100G QSFP28 or
6-port 40G QSFP28 Switch
(ToR/Aggregation Switch)

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Revision History

| Version | Revised Date | Author | Content Revised |
|------------|--------------|-----------|-----------------|
| 0.1 | 16/09/19 | Alex Chen | Initial Version |
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Scope

This documents defines the technical specification for SNX-61A0-486F used in the Open Compute Project as 10G Top of the Rack (ToR) or as an aggregation switch

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Overview

The SNX-61A0-486F Series Data Center, Top-of-Rack (ToR)/aggregation switches, with a total combined bandwidth of 880 Gbps, feature 48 ports of 10 Gbps, 6 ports of 40 Gbps or 4 ports of 100 Gbps Ethernet wire-speeds. The Layer 3 capable, bare metal system also provides an RJ-45 console port and an Out-Of-Band (OOB) management port. It also provides a micro USB interface in the front panel for storage.

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| Items | | Detailed Description |
|------------------------------------|------------|--|
| MAC Controller | | BCM56768*1 |
| PHY for 10G | | BCM82328 |
| CPU Subsystem | | |
| Modular CPU board | CPU | Intel Rangeley C2558 4 Cores/2.4GHz |
| | RAM | DDR3 4GB for Intel Rangeley CPU (reserved up to 32G) |
| | Flash | SSD 32GB for Intel Rangeley CPU (reserved up to 64G) |
| | Boot Flash | 8MB for Intel Rangeley CPU (reserved up to 16MB) |
| PHY for CPU Management Port | | BCM54616S |

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1 Feature Highlights

The SNX-60A0-486F Series Data Center, leaf/ToR switches, with a total combined bandwidth of 880 Gbps, feature 48 ports of 10 Gbps SFP+, 6 ports of 40 Gbps QSFP28 or 4 ports of 100Gbps QSFP28 at Ethernet wire-speeds. The Layer 3 capable, bare metal system also provides a RJ-45 and micro USB for storage, an Out-Of-Band (OOB) management port using RJ-45.

- OCP micro server modular CPU board with large flash and memory
Temperature warning
- Software-readable thermal monitor
- Real time clock (RTC) support
- Two Hot-swappable redundant power supply
- Four redundant (5+1) fan modules
- The following are supported
- Front panel
 - One Reset Button
 - One RJ-45 console port
 - One Out-Of-Band (OOB) 10/100/1000 Mbps RJ-45 management port
 - One Micro-USB (Type A) port for storage device

2 Physical Overview

2.1 Mechanical Dimension

| Dimension | |
|------------------------|-------------------------------|
| Height x Width x Depth | 44mm(H)440mm(W) x 487.4 mm(D) |

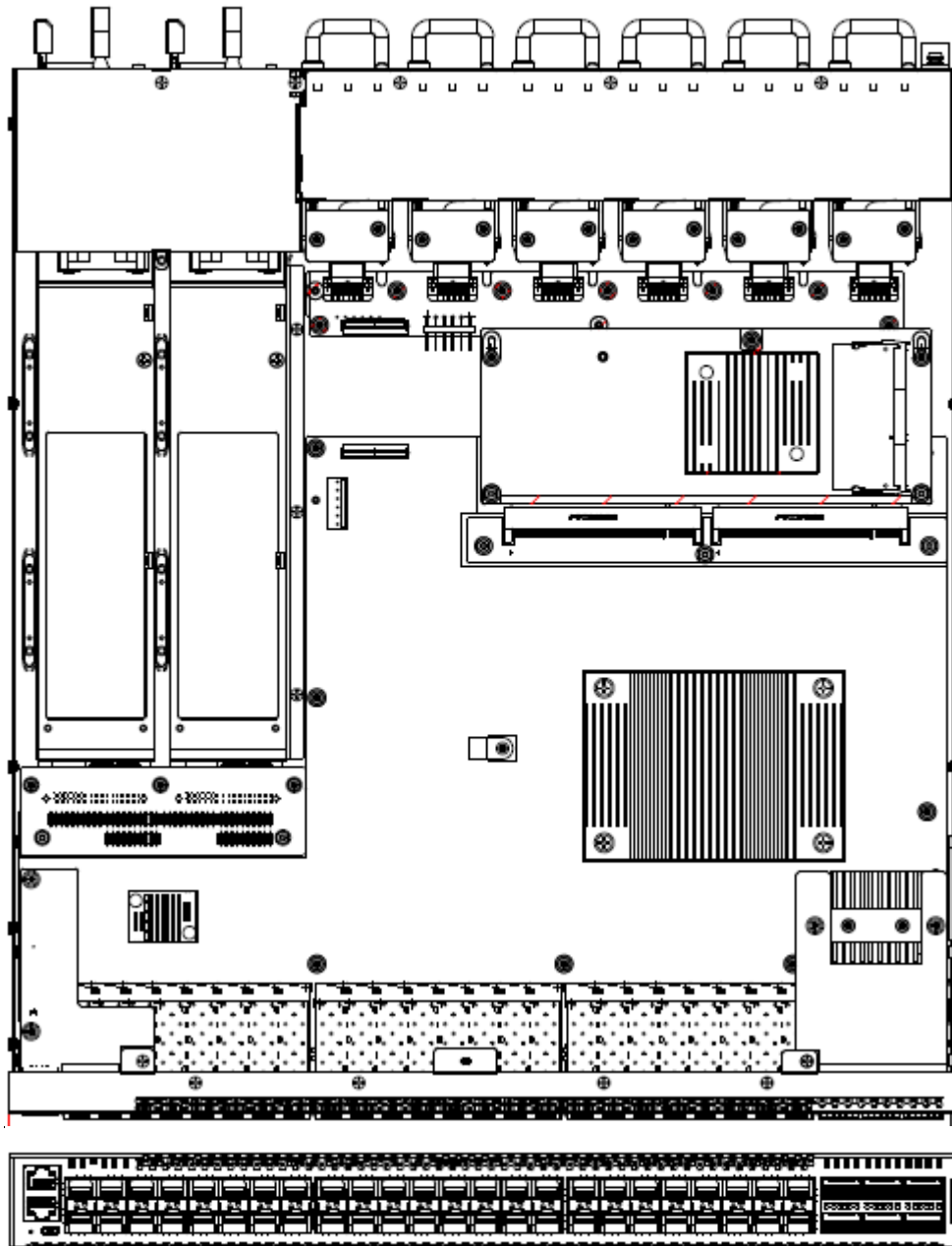


Figure 1: SNX-61A0-486F Chassis dimension

2.2 Top View

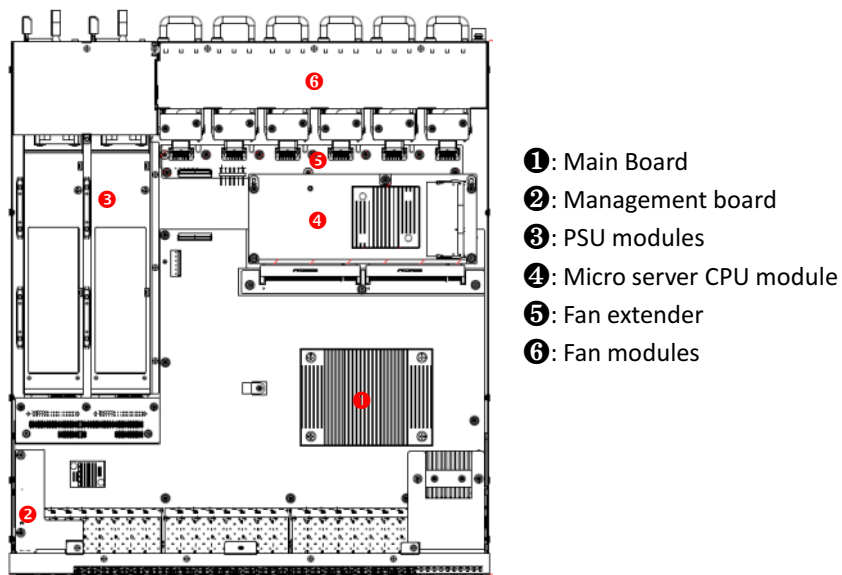
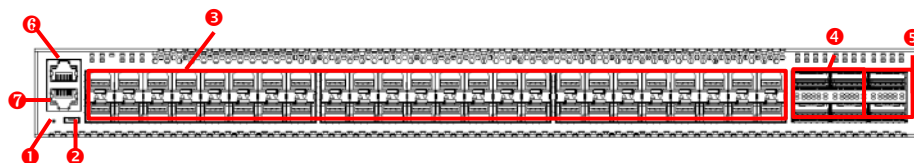


Figure 2: SNX-61A0-486F top view

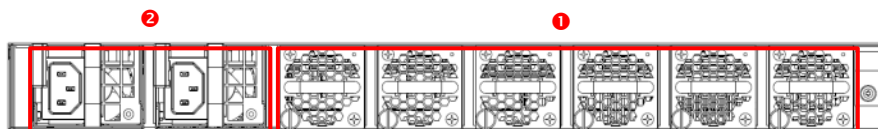
2.3 Front View



- ①: Reset button
- ②: Micro USB port for storage
- ③: 48* 10G SFP+ ports
- ④: 4* 100G QSFP28 ports
- ⑤: 4* 100G QSFP28 ports
- ⑥: MGMT port
- ⑦: Console port

Figure 3: SNX-61A0-486F front view

2.4 Rear View



- ❶: Hot swappable fan modules
- ❷: Hot swappable power supply

Figure 4: SNX-61A0-486F rear view

3 LED Definition

The following table defines the per device LEDs' behaviors:

| Items | LED Indication | Color | Behavior | Description |
|-------|----------------|-------|-------------|---|
| 1 | MGMT | Green | Solid Light | POST Passed, normal operation |
| | | | Blinking | POST in progress |
| | | | Light off | System No power |
| | | Amber | Blinking | POST failed or overheat or power supply failed or Fan module fail or over temperature |
| 2 | ACT | Green | Blinking | Packet transmitting or receiving |
| | | | Light off | No packet transmitting or receiving |
| 3 | Link | Green | Solid Light | Link up |
| | | | Light off | No link up or port disable |
| 4 | PWR (P1, P2) | Green | Solid Light | Power On |

| | | | | |
|---|--|-------|-------------|---|
| | | | Off | Power Off and no power attached |
| | | Amber | Blinking | Power supply failures, over voltage, over current, over temperature |
| 5 | FAN 1 FAN 2 FAN 3 FAN 4 FAN 5 FAN 6 | Green | Solid Light | All diagnostics pass. The module is operational. |
| | | | Off | The module is not receiving power |
| | | Amber | Blinking | Failure |

Table 1: LED behavior for system

The following defines the 10G SFP+ port LEDs' behaviors:

| Location | Speed | LED Indication | Color | Behavior | Description |
|-------------------------|--------------------------|-----------------|-------|-------------|--|
| LED Port 1~48 (10G bps) | 10G bps (High speed LED) | Link/Act/S peed | Green | Solid Light | A transceiver module or cable has been correctly installed. The port has a link and is operating at 10Gbps |
| | | | | Blinking | The port is sending or receiving data at 10Gbps |
| | 1G bps (Low speed LED) | | Amber | Solid Light | A transceiver module or cable has been correctly installed. The port has a link and is operating at 1Gbps |
| | | | | Blinking | The port is sending or receiving data at 1Gbps |
| | Off | | | Light off | Link down or no link |

Table 2: LED behavior for Port 1~48 10G Ethernet Port

The following table defines the 40G & 100G QSFP28 Ethernet port LEDs' behaviors:

| Location | Speed | LED Indication | Color | Behavior | Description |
|-----------------------|---------|----------------|-------|-------------|--|
| LED Port 49~72 | 100Gbps | Link/Act/Speed | White | Solid Light | When there is a secure 100G connection (or link) |
| | | | | Blinking | Packet transmitting or receiving |
| | 50Gbps | | Amber | Solid Light | When there is a secure 50G connection (or link) |

| | | | | | |
|--|---------------|--|-------|-------------|--|
| | | | | Blinking | Packet transmitting or receiving |
| | 40Gbps | | Blue | Solid Light | When there is a secure 40G connection (or link) |
| | | | | Blinking | Packet transmitting or receiving |
| | 25 or 10 Gbps | | Green | Solid Light | When there is a secure 25G or 10G connection (or link) |
| | | | | Blinking | Packet transmitting or receiving |
| | Off | | | Light off | No link up or port disable |

Table 3: LED behavior for Port 49~52 100G, 53~54 40G Ethernet Port

Each power supply module has a bi-color LED, which behavior is described in the following:

| LED Color | Behavior | Description |
|--------------|-------------|---|
| Green | Solid Light | Output ON and OK |
| | Blinking | AC present / AC Line 12VSB Holdup |
| | Light off | No AC power to all power supplies |
| Amber | Solid Light | Power supply critical event causing a shutdown; failure, Fan Fail |
| | Blinking | Power supply warning events where the power supply continues to operate; high temp, high power, high current, slow fan. |

Table 4: Power supply LED definition

4 Field Replaceable Components

4.1 Power Supply Modules

The switch is powered through one or two internal power supply modules.

Supported power supply modules:

- AC-770-12-FB
- AC-770-12-BF
- DC-1100-12-FB
- DC-1100-12-BF

The switch requires only one power supply for its operations, but you can include a second one for redundancy. By default the switch is installed one power supply in the

second power supply slot, and filled the first slot with a filler panel. You can order extra power supplies with forward airflow or reverse airflow. Be sure to order the same direction of airflow as is used with the switch. Never leave a power supply slot empty. Please fill the slot with a filler panel.

Please refer to Table 5 for the recommended power supply usage for each switch model.

| Switch Model Number | Equipped CPU Model | Power Supply Vender | Power Supply Model Number | Minimum Number of Power Supply Need |
|---------------------------|---------------------|---------------------|---------------------------|-------------------------------------|
| SNX-61A0-486F-AF-B | Intel Rangely C2558 | Delta Electronics | AC-770-12-FB | 1 |
| SNX-61A0-486F-AB-B | Intel Rangely C2558 | Delta Electronics | AC-770-12-BF | 1 |
| SNX-61A0-486F-DF-B | Intel Rangely C2558 | Delta Electronics | DC-1100-12-FB | 1 |
| SNX-61A0-486F-DB-B | Intel Rangely C2558 | Delta Electronics | DC-1100-12-BF | 1 |

Table 5: Power supplies usage

Power Supply connector: Molex 45984-4343

| Pin # | Descriptin | Pin # | Descriptin3 |
|------------|------------|------------|-------------|
| S1 | +12VRS+ | S13 | N/A |
| S2 | +12VRS- | S14 | SGND |
| S3 | 12LS | S15 | A0 |
| S4 | SMB ALERT | S16 | N/A |
| S5 | SDA | S17 | Vs |
| S6 | SCL | S18 | N/A |
| S7 | PSKILL | S19 | N/A |
| S8 | PSON | S20 | N/A |
| S9 | PWOK | S21 | N/A |
| S10 | A1 | S22 | N/A |
| S11 | 5VSB | S23 | +5VSB |
| S12 | 5VSB | S24 | +5BSB |
| P1 | +12_VOUT | P3 | GND |
| P2 | +12_VOUT | P4 | GND |

Table 6: Power supply connector pin out

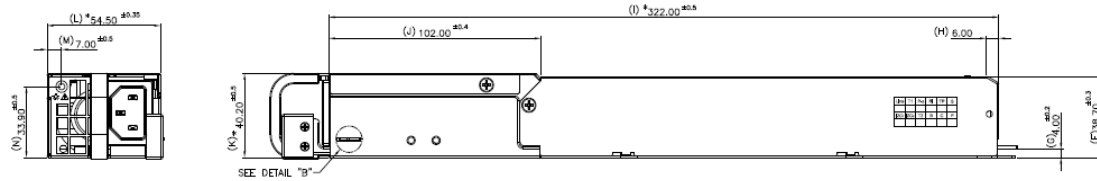


Figure 5: Power Supply Mechanical specification

LED definition on power supply

| Power Supply Condition | LED Status |
|--|--------------------|
| PSU is switched on and is running (Output ON and OK) | Green |
| No AC power to all power supplies or PSU is ON but with warning events | Off |
| PSU is OFF but 5VSB is on | 1Hz on Blink Green |
| PSU critical event causing a shutdown: failure, OCP, OTP, OVP, UVP, Fan Fail | Amber |
| PSU warning events: high temp, high power, high current, slow fan, under input voltage | 1Hz on Blink Amber |

Table 7: LED definition on power supply

FRU

FRU data format compliant with IPMI ver 1.0 (per rev 1.1 from Sept. 25, 1999) specification. The FRU device will implement the same protocols as the commonly used AT24C02 device, including the Byte Read, Sequential Read, Byte Write and Page Read protocols.

The EEPROM content is as following

| Area Type | Description |
|---------------------------|---|
| Common Header | Format Version Number |
| Internal Use Area | Not required, do not reserve |
| Chassis Info Area | Not applicable, do not reserve |
| Board Info Area | Not applicable, do not reserve |
| Product Info Area | As defined by the IPMI FRU document. Product information is defined as following |
| Field name | Field Description |
| Manufacturer Name | {Formal name of manufacturer} |
| Product Name | {Manufacturer's model number} |
| Product part/model number | Customer part number |

| | |
|--------------------------------|--|
| Product Version | Customer current revision |
| Product Serial Number | {Defined at time of manufacture} |
| Asset Tag | {Not used, code is zero length byte} |
| FRU File ID | {Not required} |
| PAD Bytes | {Added as necessary to allow for 8-byte offset to next area} |
| Mult-Record Area | <p>As defined by the IPMI FRU documentation. The following information shall be used by this power supply:</p> <p>Power Supply Information (Record type 0x00)</p> <p>DC Output (Record Type 0x01)</p> <p>No other record types are required for power supply</p> <p>Multi-Record information shall be defined as following</p> |
| Field Name (PS Info) | Field Information Definition |
| Overall Capacity (watts) | 770 |
| Peak VA | 770 |
| Inrush current (A) | 40 |
| Inrush interval (msec) | 5 |
| Low end input voltage range 1 | 100 |
| High end input voltage range 1 | 127 |
| Low end input voltage range 2 | 200 |
| High end input voltage range 2 | 240 |
| Low End Input Frequency Range | 47 |
| High End Input Frequency Range | 63 |
| Holdup Time (msec) | 12 |
| Binary flags | Set for: Hot Swap support, Auto switch and PFC |
| Peak Wattage | 839 Watts |
| Peak Wattage Time in seconds | 12 |
| Combined wattage | 770 |
| Predictive fail tach support | Supported |
| Field Name (Output) | Field Description : Two output are to be defined from #1 to #2, as follows: +12V and +5VSB |
| Output Information | Set for: Standby on +5VSB, no 5VSB on all others |
| All other output fields | Format per IPMI specification , using parameters in this specification |

Table 8: Power Supply EEPROM FRU data format

4.2 Fan Modules

The SNX-61A0-486F supports up to 5+1 fan modules. For front to rear and rear to front air flow, different types of fan modules are required.

| Air Flow Direction | Part Number |
|--------------------|---------------------|
| Front to Rear | AVC DFTA0456B2UP057 |
| Rear to Front | AVC DFTA0456B2UP058 |

Table 9: Fan Modules part number

Fan module connector: LCU SM401V-20P

| # | NAME | Description | # | NAME | Description |
|----|----------------|----------------------|----|----------------|----------------------|
| 1 | FAN_CON_TACH_0 | FAN tachometer 0 | 11 | FAN_DIR | FAN Direction |
| 2 | GND | GND | 12 | GND | GND |
| 3 | FAN_12VIN | 12V | 13 | FAN_12VIN | 12V |
| 4 | FAN_CON_PWM_0 | PWM control for FAN0 | 14 | EE_GND | EEPROM GND |
| 5 | | | 15 | EE_SDA | EEPROM SDA |
| 6 | EE_SCL | EEPROM SCL | 16 | EE_VDD | EEPROM VDD |
| 7 | EE_A0 | EEPROM ADDR_0 | 17 | FAN_CON_PWM_1 | PWM control for FAN1 |
| 8 | FAN_12VIN | 12V | 18 | FAN_12VIN | 12V |
| 9 | GND | GND | 19 | GND | GND |
| 10 | FAN_PRESENT# | Exist FAN module | 20 | FAN_CON_TACH_1 | FAN tachometer 0 |

Table 10: Fan Modules connector pin out

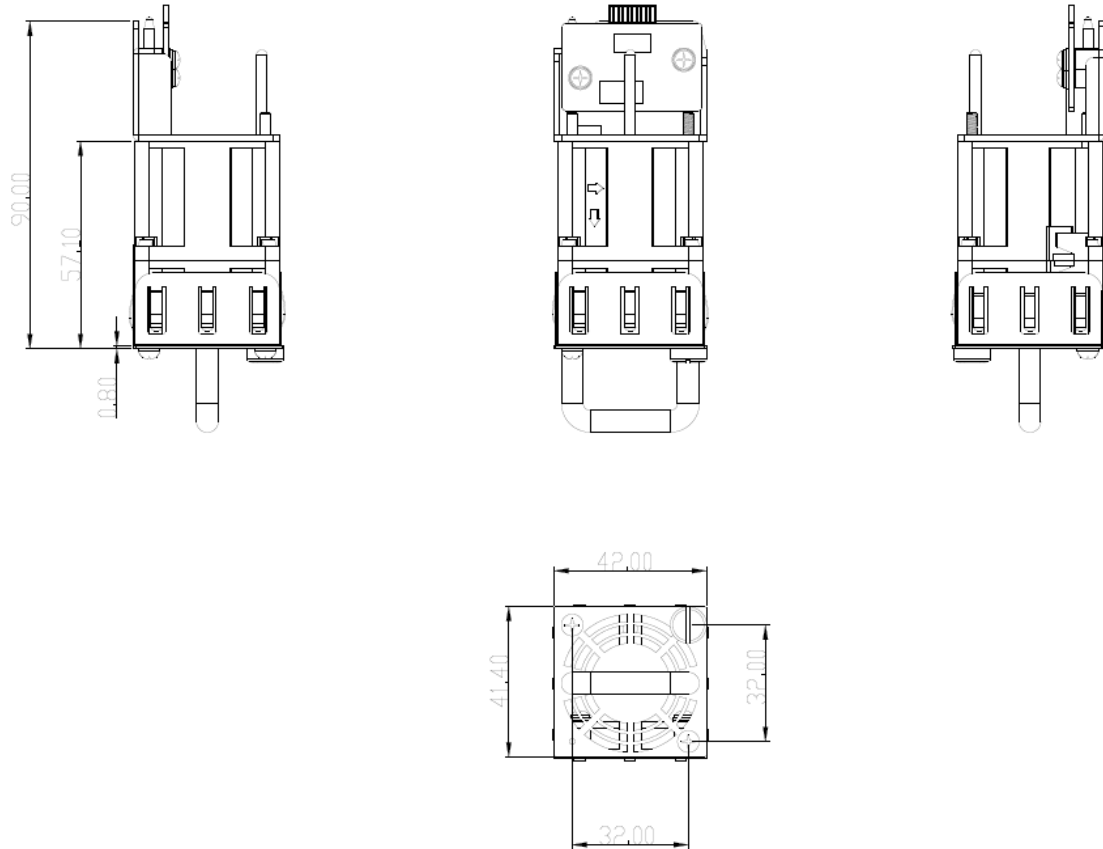


Figure 6: Fan module mechanical specification

5 System Overview

The SNX-61A0-486F comprised of the following PCB

| PCB Function | PCB Layer | Dimension (mmxmm) |
|------------------|-----------|-------------------|
| Main board | 14 | 431*326.3 |
| FAN module | 2 | 38.5*29 |
| FAN Adapter | 2 | 228*30 |
| LED board | 2 | 50*91.5 |
| PCIE Adapter | 4 | 135.5*16 |
| PSU Adapter | 4 | 132.4*41.3 |
| CPU board | 12 | 210*73.8 |
| Management board | 4 | 58*180 |

Table 11: PCBs for SNX-61A0-486F

5.1 Main PCB

The main PCB is a 12 layer PCB where the switch MAC resides. It also supports the

following functions:

- Networking I/O ports
- Management ports
- LED
- Connectivity to power supply and fan
- Power conversion circuit
- Etc

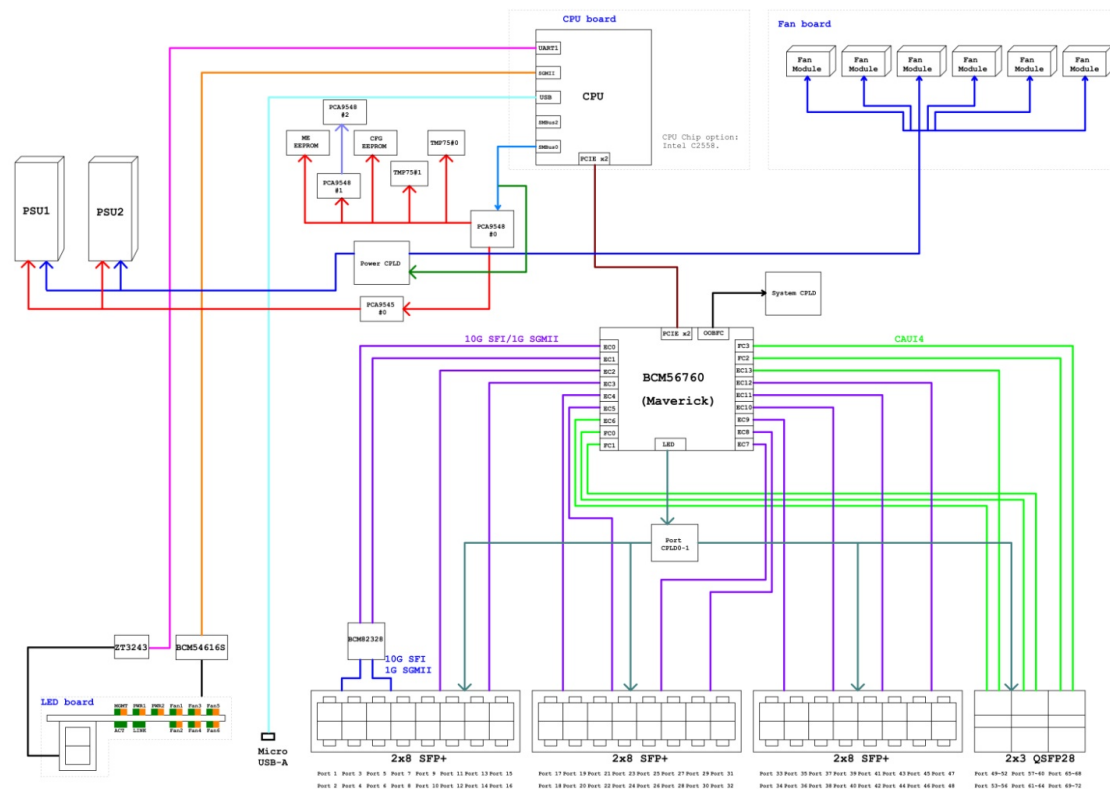


Figure 7: Main board block diagram

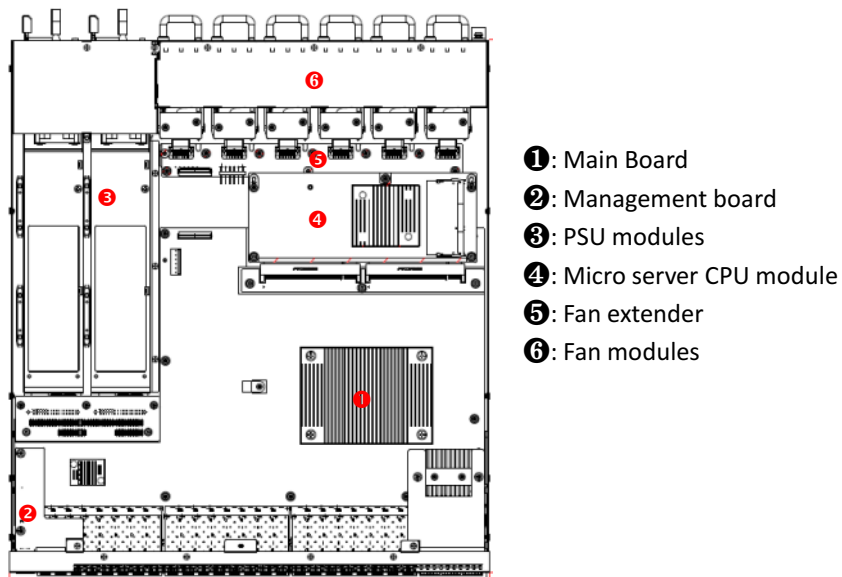


Figure 8: Main PCB top view

5.1 CPU Subsystem

The following Table is the list of key components used in SNX-60x0-486T

| Items | | Detailed Description |
|-------------------------------------|------------|-----------------------------------|
| Intel | | |
| Modular CPU board (Option 2) | CPU | Intel Rangeley C2558 4 Cores/2.4G |
| | RAM | DDR3 4GB for Intel Rangeley CPU |
| | Flash | SSD 8GB for Intel Rangeley CPU |
| | Boot Flash | 8MB for Intel Rangeley CPU |

Table 12: CPU subsystem key Components

5.1.1 Intel CPU (C2558)

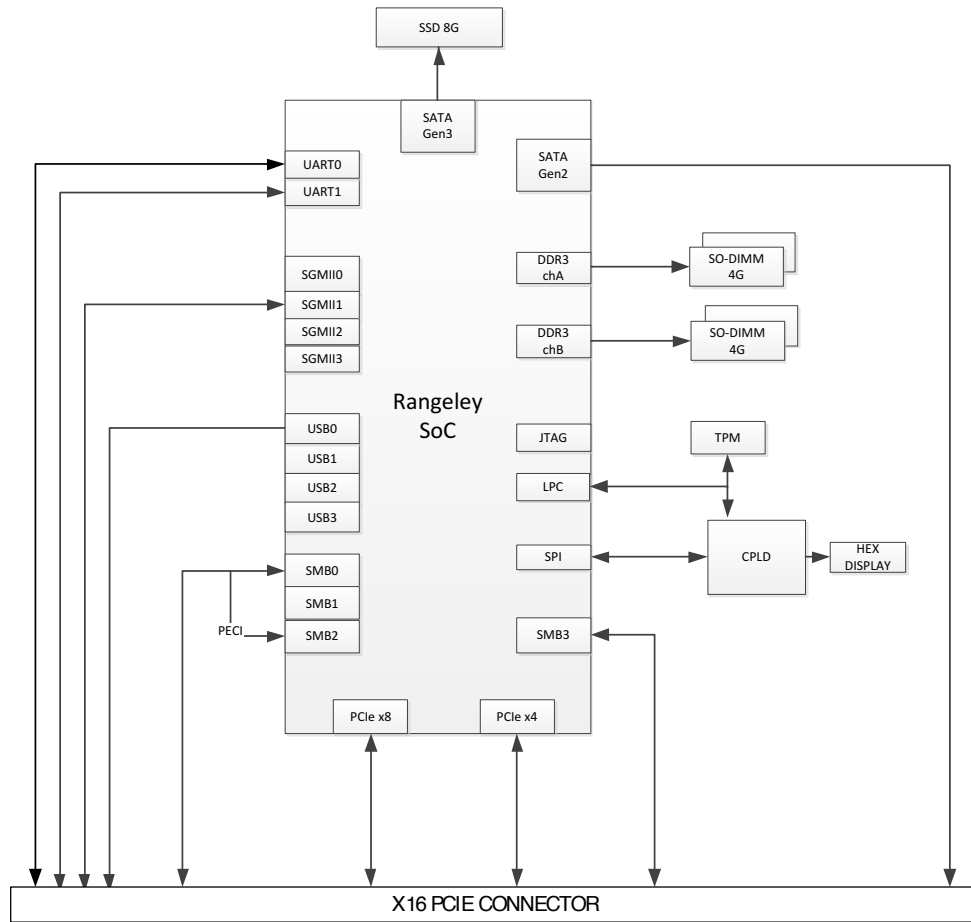


Figure 9: Intel CPU board block diagram

Intel CPU module connector: x16 PCIe Edge Connector

| For 80 PIN connector | | | |
|----------------------|------------|------------|--------------|
| # | Pin Name | # | Pin Name |
| B1 | P12V | A1 | PRSENT# |
| B2 | P12V | A2 | P12V |
| B3 | P12V | A3 | P12V |
| B4 | GND | A4 | GND |
| B5 | I2C_SCL | A5 | RFU |
| B6 | I2C_DATA | A6 | RFU |
| B7 | GND | A7 | COM_TX |
| B8 | PWR_BTN# | A8 | COM_RX |
| B9 | USB_P | A9 | GE0_MDC |
| B10 | USB_N | A10 | GE0_MDIO |
| B11 | SYS_RESET# | A11 | PCIE0_RESET# |

| KEY | | | |
|------------|----------------|------------|------------------|
| B12 | I2C_ALERT# | A12 | GND |
| B13 | GND | A13 | PCIE0_REFCLK_P |
| B14 | GND | A14 | PCIE0_REFCLK_N |
| B15 | PCIE0_TX0_P | A15 | GND |
| B16 | PCIE0_TX0_N | A16 | GND |
| B17 | GND | A17 | PCIE0_RX0_P |
| B18 | GND | A18 | PCIE0_RX0_N |
| B19 | PCIE0_TX1_P | A19 | GND |
| B20 | PCIE0_TX1_N | A20 | GND |
| B21 | GND | A21 | PCIE0_RX1_P |
| B22 | GND | A22 | PCIE0_RX1_N |
| B23 | PCIE0_TX2_P | A23 | GND |
| B24 | PCIE0_TX2_N | A24 | GND |
| B25 | GND | A25 | PCIE0_RX2_P |
| B26 | GND | A26 | PCIE0_RX2_N |
| B27 | PCIE0_TX3_P | A27 | GND |
| B28 | PCIE0_TX3_N | A28 | GND |
| B29 | GND | A29 | PCIE0_RX3_P |
| B30 | GND | A30 | PCIE0_RX3_N |
| B31 | UART0_TXD | A31 | GND |
| B32 | UART0_RXD | A32 | GND |
| B33 | GND | A33 | RFU |
| B34 | GND | A34 | RFU |
| B35 | PCIE1_REFCLK_P | A25 | GND |
| B36 | PCIE1_REFCLK_N | A36 | GND |
| B37 | GND | A37 | RFU |
| B38 | GND | A38 | RFU |
| B39 | PCIE1_RESET# | A39 | GND |
| B40 | RFU | A40 | GND |
| B41 | GND | A41 | RFU |
| B42 | GND | A42 | NIC_SMBUS_ALERT# |
| B43 | NIC_SMBUS_SCL | A43 | GND |
| B44 | NIC_SMBUS_SDA | A44 | GND |
| B45 | GND | A45 | GE0_RX_P |
| B46 | GND | A46 | GE0_RX_N |
| B47 | GE0_TX_P | A47 | GND |
| B48 | GE0_TX_N | A48 | GND |
| B49 | GND | A49 | RFU |
| B50 | GND | A50 | RFU |
| B51 | RFU | A51 | GND |
| B52 | RFU | A52 | GND |
| B53 | GND | A53 | RFU |
| B54 | GND | A54 | RFU |

| | | | |
|------------|-------------|------------|-------------|
| B55 | RFU | A55 | GND |
| B56 | RFU | A56 | GND |
| B57 | GND | A57 | RFU |
| B58 | GND | A58 | RFU |
| B59 | RFU | A59 | GND |
| B60 | RFU | A60 | GND |
| B61 | GND | A61 | RFU |
| B62 | GND | A62 | RFU |
| B63 | RFU | A63 | GND |
| B64 | RFU | A64 | GND |
| B65 | GND | A65 | PCIE1_RX0_P |
| B66 | GND | A66 | PCIE1_RX0_N |
| B67 | PCIE1_TX0_P | A67 | GND |
| B68 | PCIE1_TX0_N | A68 | GND |
| B69 | GND | A69 | PCIE1_RX1_P |
| B70 | GND | A70 | PCIE1_RX1_N |
| B71 | PCIE1_TX1_P | A71 | GND |
| B72 | PCIE1_TX1_N | A72 | GND |
| B73 | GND | A73 | PCIE1_RX2_P |
| B74 | GND | A74 | PCIE1_RX2_N |
| B75 | PCIE1_TX2_P | A75 | GND |
| B76 | PCIE1_TX2_N | A76 | GND |
| B77 | GND | A77 | PCIE1_RX3_P |
| B78 | GND | A78 | PCIE1_RX3_N |
| B79 | PCIE1_TX3_P | A79 | GND |
| B80 | PCIE1_TX3_N | A80 | GND |
| B81 | GND | A81 | P12V |
| B82 | GND | A82 | P12V |

Table 13: Intel CPU module connector pin out

Intel CPU module pin definitions

| # | Pin | Direction (from CPU side) | Required/ Configurable | Pin Definition |
|---|---------|----------------------------------|-------------------------------|---|
| | P12V | Input | Required | 12 V-AUX power |
| | I2C_SCL | Input/Output | Required | I2C clock signal. I2C is the primary sideband interface for server management functionality. 3.3 VAUX signal. Pull-up is provided on the baseboard. |

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| I2C_SDA | Input/Output | Required | I2C data signal. I2C is the primary sideband interface for server management functionality. 3.3 VAUX signal. Pull-up is provided on the baseboard. |
| I2C_ALERT# | Output | Required | I2C alert signal. Alerts the Baseboard Management Controller (BMC) that an event has occurred that must be processed. 3.3 V-AUX signal. Pull-up is provided on the baseboard. |
| NIC_SMBUS_SCL | Input/Output | Required | Dedicated SMBus clock signal for network traffic between the BMC and the NIC. 3.3 V-AUX signal. Pullup is provided on the baseboard. |
| NIC_SMBUS_SDA | Input/Output | Required | Dedicated SMBus data signal for network traffic between the BMC and the NIC. 3.3 V-AUX signal. Pullup is provided on the baseboard. |
| NIC_SMBUS_ALERT# | Output | Required | Dedicated SMBus alert signal for network traffic between the BMC and the NIC. 3.3 V-AUX signal. Pullup is provided on the baseboard. |
| PWR_BTN# | Input | Required | Power on signal. When driven low, it indicates that the server will begin its power-on sequence. 3.3 VAUX signal. Pull-up is provided on the baseboard. If PWR_BTN# is held low for < 4 seconds, then this indicates a soft (graceful) power off. Otherwise, a hard shutdown is initiated. |
| SYS_RESET# | Input | Required | System reset signal. When driven low, it indicates that the server will begin its warm reboot process. 3.3 V-AUX signal. Pull-up is provided on the baseboard. |
| PRSENT# | Output | Required | Present signal. This is pulled low on the card to indicate that a card is installed. 3.3 V-AUX signal. Pull-up is provided on the baseboard. |
| COM_TX | Output | Required | Serial transmit signal. Data is sent from the micro-server module to the BMC. 3.3 V-AUX signal. |

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| COM_RX | Input | Required | Serial receive signal. Data is sent from the BMC to the micro-server module. 3.3 V-AUX signal. |
| UART0_TXD | Output | Required | Serial transmit signal. Data is sent from the micro-server module to the BMC. 3.3 V-AUX signal. |
| UART0_RXD | Input | Required | Serial receive signal. Data is sent from the BMC to the micro-server module. 3.3 V-AUX signal. |
| GE0_TX_P/N | Output | Required | Primary Ethernet transmit signal. Data is sent from the micro-server module to the baseboard. |
| GE0_RX_P/N | Input | Required | Primary Ethernet receive signal. Data is sent from the baseboard to the micro-server module. |
| GE0_MDC | Output | Required | Primary Ethernet management interface clock signal. |
| GE0_MDIO | Input/Output | Required | Primary Ethernet management interface data signal. |
| PCIE0_RESET# | Output | Required | PCIe reset signal. If a PCIe bus is connected, this signal provides the reset signal indicating the card VRs and clocks are stable when driven high to 3.3V. |
| PCIE0_TX0/1/2/3_P/N | Output | Configurable | PCIe x4 bus-transmit signals. Data is sent from the micro-server module to the baseboard. These signals may or may not be connected on the baseboard. |
| PCIE0_RX0/1/2/3_P/N | Input | Configurable | PCIe x4 bus-receive signals. Data is sent from the baseboard to the micro-server module. These signals may or may not be connected on the baseboard. |
| PCIE0_REFCLK_P/_N | Output | Configurable | PCIe reference clock. This signal may or may not be connected on the baseboard. |
| PCIE1/2_RESET# | Output | Configurable | PCIe reset signals for to 2x additional PCIe |

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| | | | buses. If a PCIe bus is connected, this signal provides the reset signal indicating the card VRs and clocks are stable when driven high to 3.3V. |
| PCIe1_TX0/1/2/3_P/N | Output | Configurable | Second set of PCIe x4 bus-transmit signals. Data is sent from the microserver module to the baseboard. These signals may or may not be connected on the baseboard. |
| PCIe1_RX0/1/2/3_P/N | Input | Configurable | Second set of PCIe x4 bus-receive signals. Data is sent from the baseboard to the micro-server module. These signals may or may not be connected on the baseboard. |
| PCIe1_REFCLK_P/_N | Output | Configurable | Two additional PCIe reference clocks. These signals may or may not be connected on the baseboard. |
| USB_P/N | Input/Output | Configurable | USB 2.0 differential pair. |
| RSVD | Input/Output | Configurable | Available differential pairs that could be configured as PCIe, SATA, SAS, Ethernet, or other high-speed interfaces. |
| RFU | Input/Output | Not connected | These pins are reserved for future use and are not used. |

Table 14: Intel CPU module connector Pin Definitions

5.1.1.1 DDR3 SDRAM

The Rangeley Memory Controller supports up to 64 GB. The memory controller supports a 64-bit data bus with 8-bit ECC. When only one of the two memory channels is used in a platform board design, Channel 0 must be used. In all designs, Channel 0 must be populated by DRAM devices. Within each memory channel DIMMs are populated in slot order; slot 0 is populated first and slot 1 last. If a DIMM has two ranks, the ranks must be symmetrical (same chip width, same chip density, and same total memory size per rank). If both memory channels of the memory controller are used, then both channels must be populated identically. The CPU board is used a DDR3-1333 4GB SO-DIMM.

5.1.1.2 PCIe Interface

The Rangeley has up to 16 PCIe ports. Each port consists of a Transmitter differential pair and a Receiver differential pair which are in the 1.0-Volt Core power well of the SoC. The Rangeley supports devices with 5.0 GT/s and 2.5 GT/s capabilities.

6 IO and Connectors

6.1 RS232 Interface

- Baud Rate: s/w define
- Data bits: 8
- Stop Bit: 1
- Parity: None
- Flow control: None

6.2 Management Ethernet Interfaces

There are one single PHY on front panel PCBA, use SGMII interface from CPU module convert to 10/100/1000 RJ-45 GbE Management port. The PHY used is Marvell 88E1112.

6.3 USB Interface

The CPU contains one Enhanced Host Controller Interface (EHCI) and complies to the EHCI 1.0 Specification. The EHCI supports up to four USB 2.0 root ports. USB 2.0 allows data transfers up to 480 Mbps. The controller integrates a Rate-Matching Hub (RMH) to support USB 1.1 devices. The USB Port 1 interface is configured by the debug software to be a debug port.

7 Power/Environmental/Agency Certifications

| Power | |
|--|--|
| Number of power supply | 2 |
| Power supply types | AC (forward and reversed airflow) DC (forward and reversed airflow) |
| Typical operating power | TBD |
| Maximum power | 511W |
| AC PSUs <ul style="list-style-type: none"> ● Input voltage ● Frequency ● Efficiency | 770W <ul style="list-style-type: none"> ● 100 to 240 VAC ● 50 to 60 Hz |
| DC PSUs <ul style="list-style-type: none"> ● Input voltage range | 1100W |

| | |
|--|--|
| ● Efficiency | ● 40.5V/23.8A 48V/19.0A -60V/15.6 |
| Environment | |
| Operating temperature | 0 ~ 45°C (at sea level with Fan Failure condition) |
| Altitude | 0 ~ 10,000ft at 40°C* |
| Storage temperature | -40~70°C |
| Operating relative humidity | 0%-95% RH (non-condensing) |
| Storage relative humidity | 0%~95% RH (non-condensing) |
| Dimensions (height x width x depth) | 44mmx440mmx487.4mm |
| Weight | TBD |

Table 15: Power consumption and environment table

| Regulatory Standards Compliance | | | |
|---------------------------------|----|---|-----------------|
| Regulatory compliance Safety | | Comply with CE markings per directives 2004/108/EC and 2006/95/EC FCC/IC Report Class A BSMI UL/cUL Listed Mark CCC | |
| Safety | | IEC60950-1 FCC/IC Report Class A EN 60950-1 FCC/IC Report Class A UL/CSA 60950-1 CNS 14336-1 GB4943.1 | |
| EMC: Emissions | | IEC60950-1 FCC/IC Report Class A EN 60950-1 FCC/IC Report Class A UL/CSA 60950-1 CNS 14336-1 GB4943.1 | |
| RoHS Requirement | | | |
| Level | # | Description | Limitation/ ppm |
| A | A1 | Cadmium/ Cadmium Compounds | 80 |
| | A2 | Hexavalent Chromium/ Hexavalent Chromium Compounds | 800 |
| | A3 | Lead/ Lead Compounds | 800 |
| | A4 | Mercury/ Mercury Compounds | 800 |
| | A5 | Polybrominated Biphenyls (PBBs) | 800 |
| | A6 | Polybrominated Diphenylethers (PBDEs) | 800 |
| Reliability Test Reports | | | |

| Test Items | Standards | Remarks |
|--------------------------------------|---|---|
| MTBF Prediction Report | Telcordia SR-332, Issue 2 | |
| Free Fall Test Report | IEC 60068-2-32: Basic Environmental Testing Procedures Part 2: Tests Test Ed: Free Fall-Second Edition; Incorporating Amendment 1; Amendment 2: 10-1990 | <ul style="list-style-type: none"> Drop Range: \leq 20Kg,1000mm; \leq 50kg, 500mm; Max. Load: 500 kg; FCS: 1 carton. |
| Vibration Test Report | IEC 60068-2-34:1973: Environmental testing Test Fd: Random vibration wide band-General requirements | <ul style="list-style-type: none"> Frequency: 20Hz ~500Hz; Method: Random; Test Time: 30 min/Per Axis; FCS: 1 carton. |
| Storage Test Report | IEC 60068-2-48: Basic Environmental Testing Procedures Part 2: Tests Guidance on the Application of the Tests of IEC Publication 68 to Simulate the Effects of Storage-First Edition | <ul style="list-style-type: none"> Low Temp.: -40°C, 72Hours High Temp. /Low Humidity : 70 °C, 25%R.H., 72Hours High Temp. /High Humidity : 40 °C, 95%R.H., 96Hours FCS: 1 carton |
| Cold Test Report | IEC 60068-2-1: Environmental Testing Part 2: Tests - Tests A: Cold-Fifth Edition; Amendment 1-1993; Amendment 2-1994 | <ul style="list-style-type: none"> Temperature: -10\pm3°C Humidity: Uncontrolled Test Time: 72 Hours FCS: 2 sets |
| Dry Heat Cyclic Test Report | IEC 60068-2-2: Basic Environmental Testing Procedures Part 2: Tests - Tests B: Dry Heat-Fourth Edition; Supplement A-1976; Amendment 1-1993; Amendment 2-1994 | <ul style="list-style-type: none"> Temperature: 55\pm2°C Humidity: 5%R.H. Test Time: 72 Hours FCS: 2 sets |
| Damp Heat Steady State Report | IEC 60068-2-78: Environmental Testing - Part 2-78: Tests - Test 2-78: Body Cab: Damp Heat, Steady State-First Edition; (Replaces IEC 60068-2-3 and 60068-2-56) | <ul style="list-style-type: none"> Temperature: 40\pm2°C Humidity: 95\pm2-3%R.H. Test time: 96 Hours FCS: 2 sets |
| Damp Heat Cyclic Report | IEC 60068-2-30: Basic Environmental Testing Procedures Part 2: Tests - Test Db and Guidance: Damp Heat, Cyclic (12 + 12-Hour Cycle)-Second Edition; Amendment 1-08/1985 | <ul style="list-style-type: none"> Temperature: 40\pm2°C Humidity: 95\pm2-3%R.H. Cycle Time: 24 Hours Number of Cycle: 2 Cycles FCS: 2 sets |
| ESD Simulation Test Report | IEC 61000-4-2: Electromagnetic Compatibility (EMC) - Part 4-2: Testing and Measurement Techniques - Electrostatic Discharge Immunity Test-Edition 1.2; Edition 1:1995 | <ul style="list-style-type: none"> Air Discharge: \pm8KV; Contact Discharge: \pm4KV; FCS: 1 set. |

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| | Consolidated with Amendments 1:1998 and 2:2000 | |
| Electrical Isolation Test Report | For Class I equipment only. | <ul style="list-style-type: none"> • Primary (L-N) to Earth (Metal frame or Ground Pin): Minimum 1,5 kV ac, at least 60 seconds; • Lan Port (RJ-45) to Ground (Metal frame) Minimum 1,5 kV ac at least 60 seconds. |

Table 16: Regulatory Standards Compliance table